

### Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	$I_D$
600V	$2.5\Omega@10V$	5A

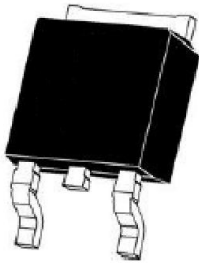
### Feature

- Fast switching capability
- Improved dv/dt capability, high ruggedness

### Application

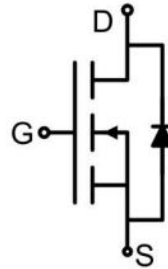
- High Speed Switching Applications
- Power Supplies and Adaptors

### Package

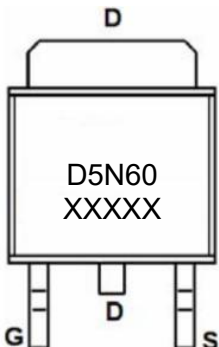


TO-252AB

### Circuit diagram



### Marking



### Absolute maximum ratings (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	600	V
Gate-Source Voltage	V <sub>GS</sub>	±30	V
Continuous Drain Current(T <sub>C</sub> =25°C)	I <sub>D</sub>	5	A
Continuous Drain Current(T <sub>C</sub> =100°C)	I <sub>D</sub> (100°C)	3.2	A
Pulsed Drain Current <sup>1)</sup>	I <sub>DM</sub>	20	A
Power Dissipation(T <sub>C</sub> =25°C)	P <sub>D</sub>	35	W
Thermal Resistance,Junction-to-Case	R <sub>θJC</sub>	4	°C/W
Single pulse avalanche energy <sup>2)</sup>	E <sub>AS</sub>	50	mJ
Junction Temperature	T <sub>J</sub>	150	°C
Storage Temperature Range	T <sub>STG</sub>	-55 ~ +150	°C

### Electrical characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> =250μA	600			V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> =600V, V <sub>GS</sub> = 0V			1	μA
Gate-body leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =±30V, V <sub>DS</sub> = 0V			±100	nA
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	2.0		4.0	V
Drain-source on-resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =2A		2.04	2.5	Ω
Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =15V, I <sub>D</sub> =2A		3.1		S
<b>Dynamic characteristics<sup>5)</sup></b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f =1MHz		564		pF
Output Capacitance	C <sub>oss</sub>			66		
Reverse Transfer Capacitance	C <sub>rss</sub>			12		
Gate Resistance	R <sub>g</sub>			2.3		Ω
Total Gate Charge <sup>3)</sup>	Q <sub>g</sub>	V <sub>DS</sub> =480V, V <sub>GS</sub> =10V, I <sub>D</sub> =5A, I <sub>G</sub> =1mA <sup>3,4)</sup>		13		nC
Gate-Source Charge	Q <sub>gs</sub>			4.1		
Gate-Drain Charge	Q <sub>gd</sub>			4.9		
Turn-on delay time <sup>3)</sup>	t <sub>d(on)</sub>	V <sub>DS</sub> =300V, V <sub>GS</sub> =10V, I <sub>D</sub> =5A, R <sub>G</sub> =25Ω <sup>3,4)</sup>		31		nS
Turn-on rise time	t <sub>r</sub>			76		
Turn-off delay time	t <sub>d(off)</sub>			61		
Turn-off fall time	t <sub>f</sub>			56		
<b>Source-Drain Diode characteristics</b>						
Diode Forward voltage <sup>3)</sup>	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>SD</sub> =5A			1.4	V
Diode Forward Current	I <sub>S</sub>				5	A
Reverse Recovery Time <sup>3)</sup>	t <sub>rr</sub>	I <sub>F</sub> =5A, di/dt = 100A/μs		250		nS
Reverse Recovery Charge	Q <sub>rr</sub>				4.5	

Notes:

- 1) Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2) L = 25mH, I<sub>AS</sub> = 2A, V<sub>DD</sub> = 50V, R<sub>G</sub> = 25 Ω, Starting T<sub>J</sub> = 25°C.
- 3) Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%.
- 4) Essentially independent of operating temperature.
- 5) Guaranteed by design, not subject to production.

## Typical Characteristics

Fig.1 Output characteristics

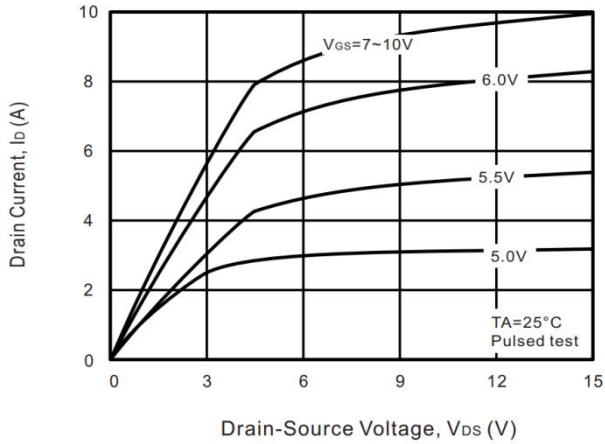


Fig.2 Power Dissipation

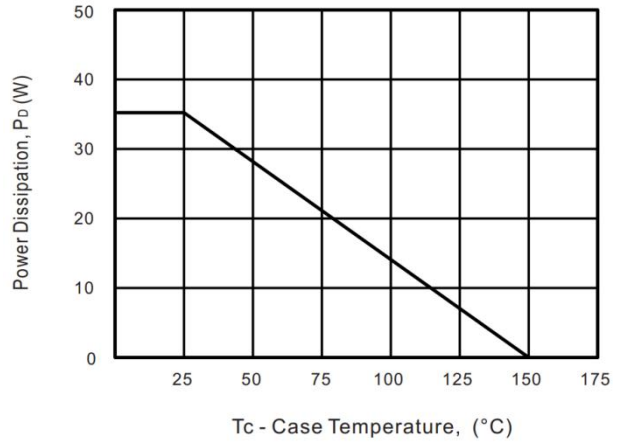


Fig.3 Drain Current Derating

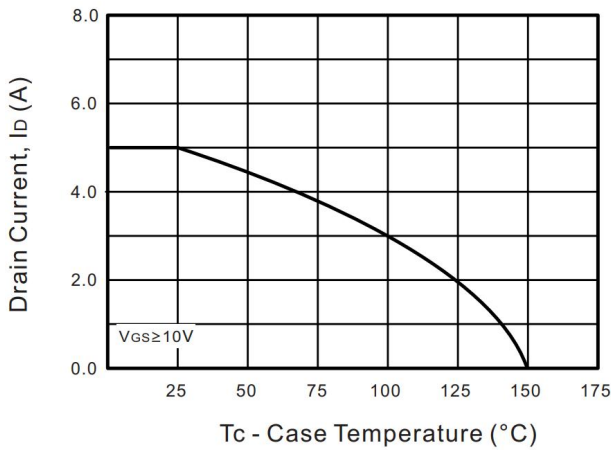


Fig.4 Drain-Source On-Resistance vs. Drain Current

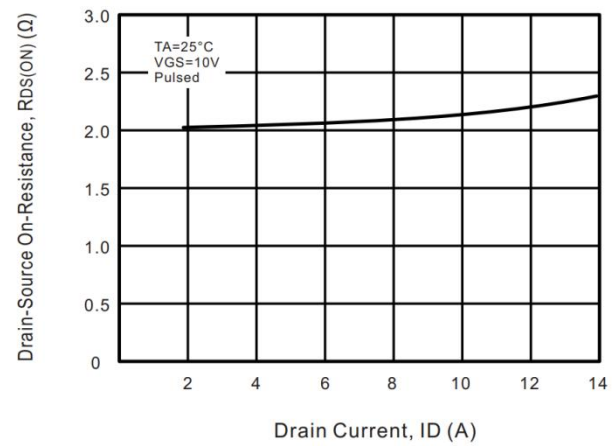


Fig.5 Gate Threshold Voltage vs. Junction Temperature

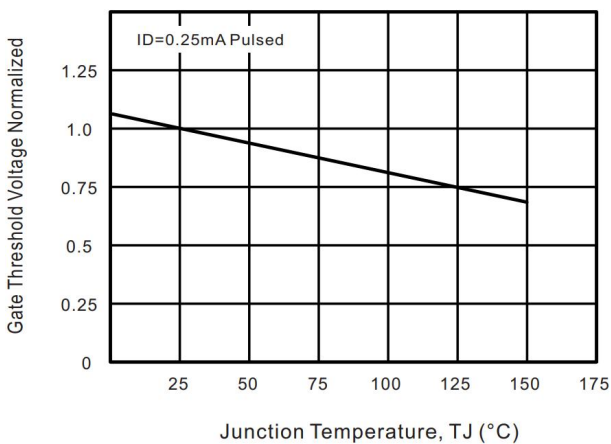
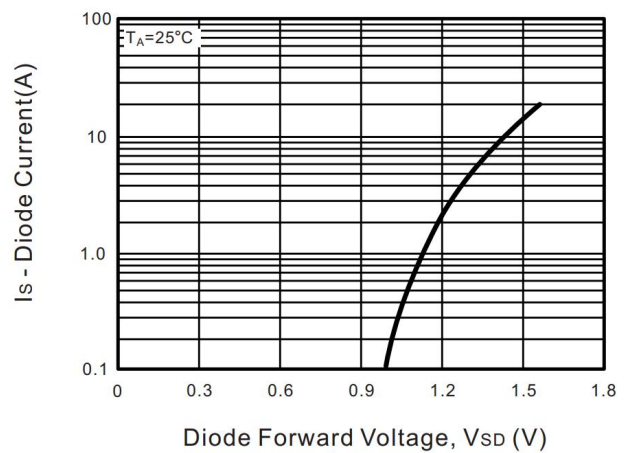


Fig.6 Body-diode Forward Characteristics



### Typical Characteristics

Fig.7 Drain-Source On-Resistance vs. Junction Temperature

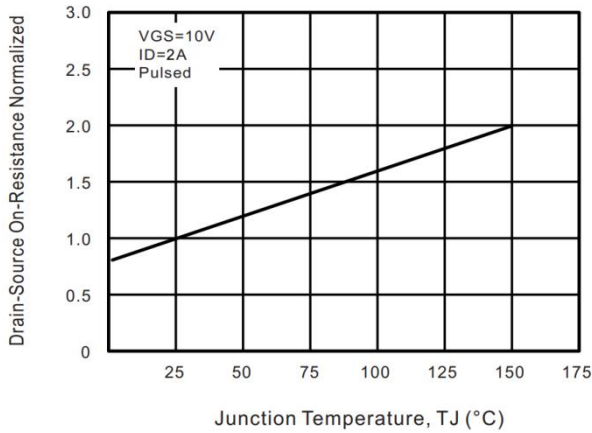


Fig.8 Breakdown Voltage vs. Junction Temperature

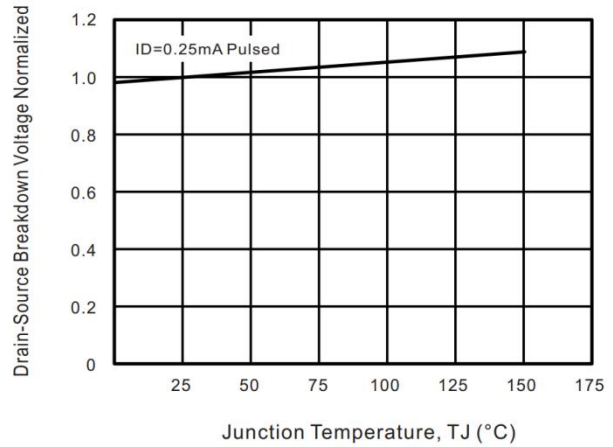


Fig.9 Capacitance Characteristics

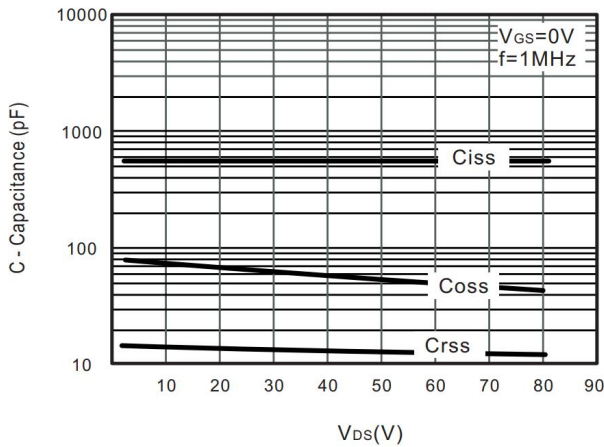


Fig.10 Gate Charge Characteristics

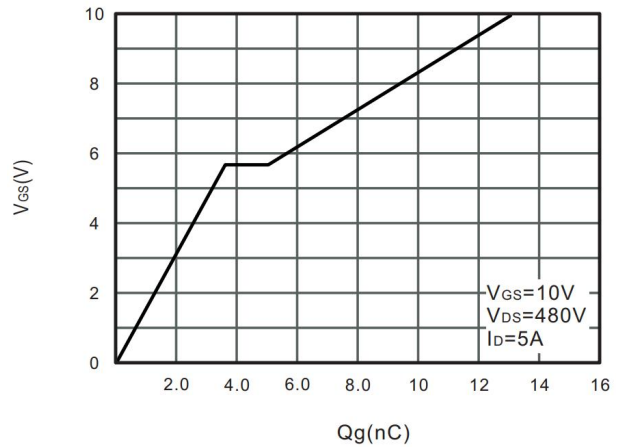


Fig.11 Safe Operating Area

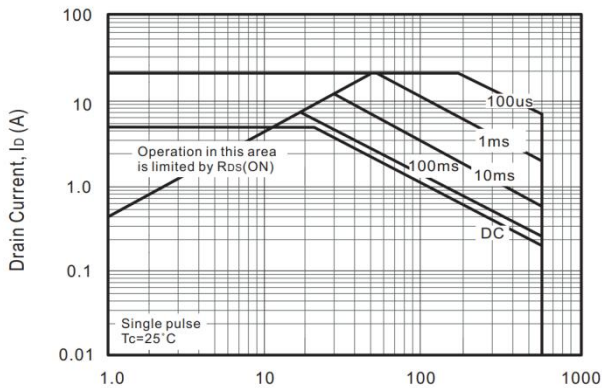
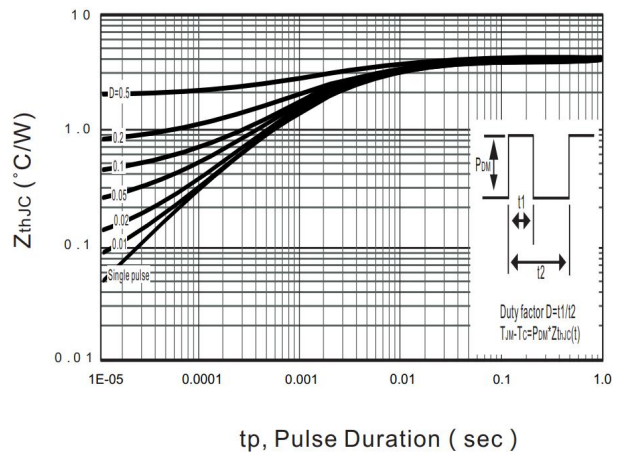
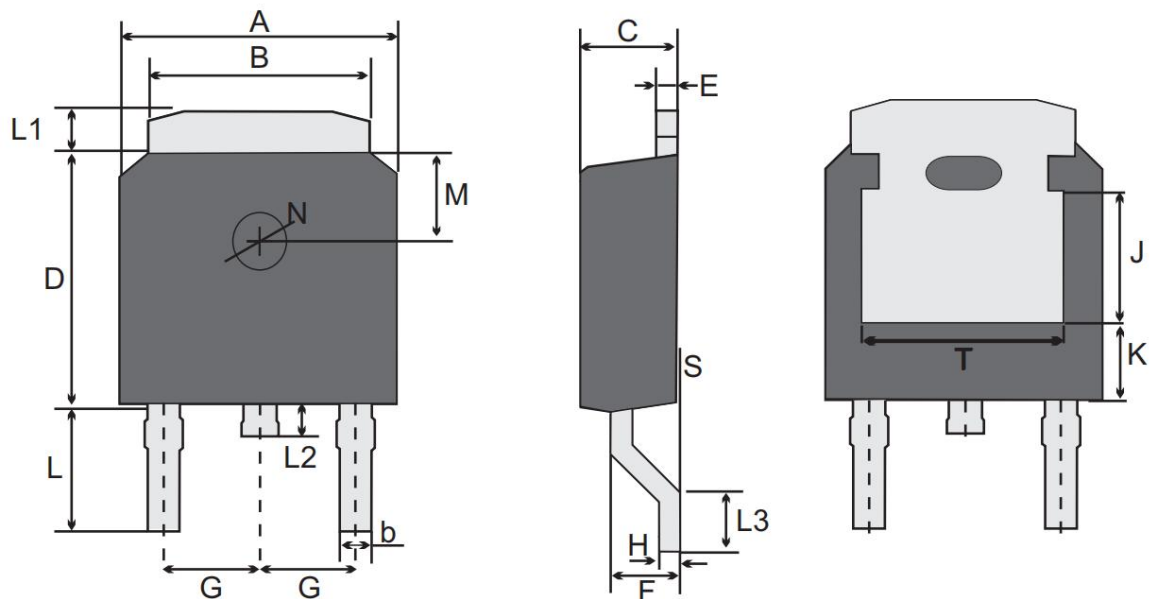


Fig.12 Max. Transient Thermal Impedance



### TO-252AB Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	6.300	6.700	0.248	0.264
B	5.130	5.530	0.202	0.218
b	0.660	0.860	0.026	0.034
C	2.100	2.500	0.083	0.098
D	5.900	6.300	0.232	0.248
E	0.410	0.610	0.016	0.024
F	1.270	1.870	0.050	0.074
G	2.300 TYP.		0.091 TYP.	
H	0.450	0.550	0.018	0.022
L	2.600	3.000	0.102	0.118
L1	0.800	1.200	0.031	0.047
L2	0.600	1.000	0.024	0.039
L3	1.000	1.750	0.039	0.069
S	0.000	0.230	0.000	0.009
M	1.800 TYP.		0.071 TYP.	
N	1.300 TYP.		0.051 TYP.	
J	3.200 REF		0.126 REF	
K	1.800 REF		0.071 REF	
T	4.830 REF		0.190 REF	